



DYNA-PURGE[®] C

Product Information Sheet

Designed for Purging Transparent Resins

DYNA-PURGE C is a clear, non-abrasive, non-chemical “engineered” thermoplastic purging compound, formulated to purge high clarity resins such as PMMA, PET, PC, SAN, GPPS, etc. A non-melting but softening thermoplastic scrubs the screw and barrel of both injection molding machines and extruders, while the carrier matrix flushes away impurities.

FEATURES & BENEFITS OF DYNA-PURGE C

- Excellent for color to clear changes, resin changes, preventative machine maintenance, and before manual cleaning
- Effective through a wide temperature range 400°F-590°F(204°C-310°C)
- Easy to use – no process adjustment necessary – use at the resident resin processing temperature and RPM speed
- Non-abrasive, non-melting but softening thermoplastic, which thoroughly loosens carbonized and degraded resin, allowing it to be flushed out of the system
- Safe, non-hazardous, with no chemicals – ingredients are FDA compliant
- Heat stable – recommended during shutdown and start-up
- Low “cost-per-purge” – only small quantity needed to be effective
- No mixing required – simply use “as is”
- Unlimited shelf life

Dyna-Purge is the top performing purging compound on the market today. The product line offers superior cleaning and economic value over in-house methods and other commercial purging compounds. We invite you to sample Dyna-Purge at no charge, so you can prove it to yourself. Dyna-Purge, the industry leader for over 25 years!

See other side for information on “Suggested Operating Procedures”

SUGGESTED OPERATING PROCEDURES DYNA-PURGE® C

	INJECTION	EXTRUSION
Temperature Range:	400° F - 590° F (204° C - 310° C)	400° F - 590° F (204° C - 310° C)
Types of Resins:	All, especially PMMA, PET, PC, SAN, GPPS etc...	All, especially PMMA, PET, PC, SAN, GPPS etc...
Minimum Clearance:	Nozzle- .030 inch or .75mm	Die- .030 inch or .75mm
Hot runner systems:	Contact Sales Consultant for more information	N / A
Screen Packs or other flow restrictions:	Must have min clearance of .030 inch or .75mm	Must be removed (otherwise use Dyna-Purge X or SF)
Amount of Purge:	Approx. 2 lbs.(.9 kgs) per diameter inch(2.5 cm) of screw	Approx. 10 lbs.(4.5 kgs) per diameter inch(2.5 cm) of screw, L:D dependent

SAFETY FIRST: Before performing this procedure, it is the machine operator's responsibility to be familiar with the equipment in use, to wear the appropriate personal protective equipment, and to make sure that unauthorized persons are clear of the affected area.

SUGGESTED PROCEDURE FOR PURGING THE BARREL AND SCREW

1. Maintain temperature / RPM settings used for resident resin.
2. Retract nozzle from the mold, leaving ample room for purge to exit nozzle.
3. Thoroughly clean the hopper.
4. Empty barrel and starve the screw of the resident resin; leave screw forward.
5. Set machine shot size between 50% and maximum allowable setting.
6. Rotate the screw and aggressively meter Dyna-Purge, one scoop at a time, into empty hopper or side port until screw retracts to appropriate shot size setting. When the screw reaches the shot size set point, move the screw forward and repeat the process until the purge is clean and free of contamination.

Note: On some open nozzle machines, the screw may not move back while rotating/feeding Dyna-Purge into barrel. If so, continually purge Dyna-Purge through nozzle until purge is clean and free of contamination. (Actual amount used depends on the condition of the machine prior to purging.)

7. Adjust the temperature settings for your next production resin.
8. Flush out Dyna-Purge residue with next resin.
9. Start to make parts with next resin.

YOUR EQUIPMENT IS NOW READY FOR YOUR NEXT PRODUCTION RUN!

- SEE OUR SUGGESTED PROCEDURES FOR SHUTDOWN & START-UP ●

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